

BB153 VHF variable capacitance diode Rev. 4 — 6 September 2011

Product data sheet

1. Product profile

1.1 General description

The BB153 is a variable capacitance diode, fabricated in planar technology and encapsulated in the SOD323 (SC-76) very small SMD plastic package.

The excellent matching performance is achieved by gliding matching and a Direct Matching Assembly (DMA) procedure.

1.2 Features and benefits

- Excellent linearity
- Excellent matching to 2 % DMA
- Very small SMD plastic package
- C_{d(28V)}: 2.6 pF; C_{d(1V)} to C_{d(28V)} ratio: 15
- Very low series resistance.

1.3 Applications

- Electronic tuning in VHF television tuners, band B up to 460 MHz
- Voltage Controlled Oscillators (VCO).

2. Pinning information

Pin	Description	Simplified outline ^[1] S	Symbol
1	cathode		
2	anode		4
			sym008

[1] The marking bar indicates the cathode.

3. Ordering information

Table 2.Ordering information

Type number	pe number Package		
	Name	Description	Version
BB153	SC-76	plastic surface mounted package; 2 leads	SOD323



4. Marking

Table 3. Marking	
Type number	Marking code
BB153	PC

5. Limiting values

Table 4.Limiting valuesIn accordance with the Absolute Maximum Rating System (IEC 60134).					
Symbol	Parameter	Conditions	Min	Max	Unit
V _R	reverse voltage		-	32	V
V _{RM}	peak reverse voltage	in series with a 10 k Ω resistor	-	35	V
I _F	forward current		-	20	mA
T _{stg}	storage temperature		-55	+150	°C
Tj	junction temperature		-55	+125	°C

6. Characteristics

Table 5.Characteristics

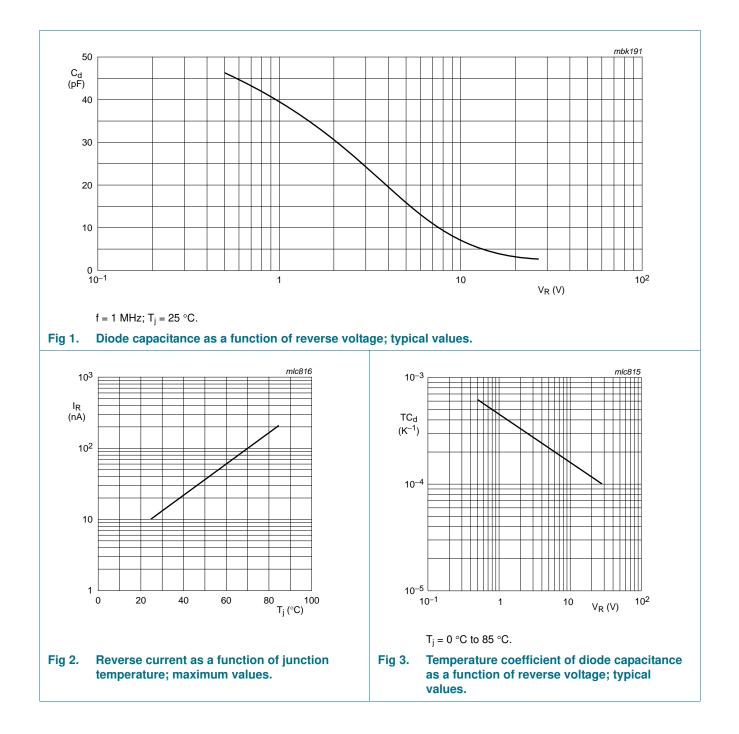
 $T_i = 25 \ ^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
l _R re	reverse current	see Figure 2				
		V _R = 30 V	-	-	10	nA
		$V_{R} = 30 \text{ V}; \text{ T}_{j} = 85 ^{\circ}\text{C}$	-	-	200	nA
r _s	diode series resistance	f = 100 MHz; C _d = 30 pF	-	0.65	0.8	Ω
C _d diode		f = 1 MHz; see Figure 1 and 3				
ca	capacitance	V _R = 1 V	34.65	-	42.35	рF
		V _R = 28 V	2.361	2.6	2.754	рF
$\frac{C_{d(1V)}}{C_{d(2V)}}$	capacitance ratio	f = 1 MHz	-	1.3	-	
$\frac{C_{d(1V)}}{C_{d(28V)}}$	capacitance ratio	f = 1 MHz	13.5	15	-	
$\frac{C_{d(25V)}}{C_{d(28V)}}$	capacitance ratio	f = 1 MHz	-	1.08	-	
$\frac{\Delta C_d}{C_d}$	capacitance matching	$V_R = 1 V$ to 28 V; in a sequence of 10 diodes (gliding)	-	-	2	%

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7. Package outline

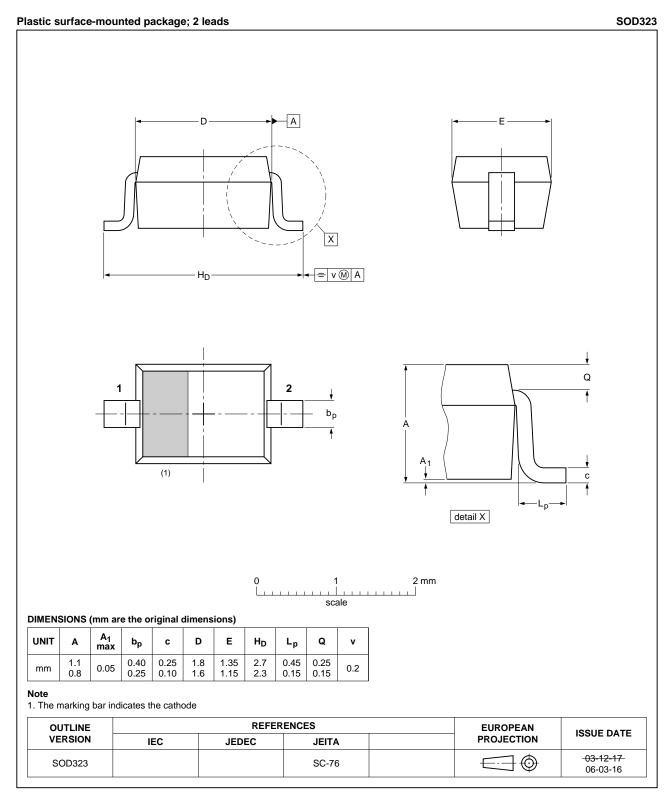


Fig 4. Package outline SOD323 (SC-76).

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8. Revision history

Table 6. Revision	n history			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BB153 v.4	20110906	Product data sheet	-	BB153 v.3
Modifications:		of this data sheet has been of NXP Semiconductors.	redesigned to comply v	vith the new identity
	 Legal texts 	have been adapted to the n	ew company name whe	ere appropriate.
	 Package ou 	utline drawings have been u	odated to the latest vers	sion.
BB153 v.3 (9397 750 13829)	20041005	Product data sheet	-	BB153 v.2
BB153 v.2 (9397 750 12646)	20040225	Product specification	-	BB153 v.1
BB153 v.1 (9397 750 02654)	19971217	Product specification	-	-

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9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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